This listing of claims will replace all prior versions, and listings, of claims in the application

LISTING OF CLAIMS

- 18. (currently amended) A surface-mounted LED arrangement,
- 5 comprising:

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- a printed circuit board having a principal surface and a secondary surface, said printed circuit board comprising a plastic material,
- a plurality of LEDs arranged on said principal surface,
- a metallic layer provided on said secondary surface-electrically-insulated from the LEDs,-and
- a cooling member connected to said secondary surface, wherein said printed circuit board is secured to said cooling member with at least one of a thermally conductive paste, a thermally conductive adhesive and a thermally conductive film, and
- wherein said secondary surface is applied to one of a curved surface, a singly angled surface or a multiply angled surface of said cooling member, or to a thermally conductive partial region of a device housing, or to an automobile chassis, such that said plurality of LEDs are arranged in a spatial form determined by said one of a curved surface, singly angled surface or multiply angled surface of said cooling member.
- 19. (previously presented) The LED arrangement according to claim 18, wherein said metallic layer comprises copper or other metal having good thermal25 conductivity.

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- 20. (previously presented) The LED arrangement according to claim 19, wherein said printed circuit board comprises a flexible printed circuit board structure.
- 5 21. (cancelled).

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- 22. (currently amended) The LED arrangement according to claim <u>18</u> 21, wherein said metallic layer comprises a meander-like lateral structure.
- 10 23. (previously presented) The LED arrangement according to claim 22, wherein said cooling member comprises a metal.
- 24. (previously presented) The LED arrangement according to claim 23, wherein a surface of said cooling member remotely positioned from said printed
 15 circuit board is blackened, comprises cooling ribs or is provided with a roughened surface.
 - 25. (previously presented) The LED arrangement according to claim 24, wherein said plurality of LEDs are provided with lenses.
 - 26. (previously presented) The LED arrangement according to claim 25, wherein said printed circuit board electrically insulates said metallic layer from said plurality of LEDs.
- 27. (previously presented) The LED arrangement according to claim 26, wherein said printed circuit board comprises one of an epoxy resin, a polyester or a polyamide.

- 28. (currently amended) A lighting device comprising the LED arrangement according to claim 18 27.
- 29. (previously presented) The lighting device comprising an LED arrangement according to claim 28, wherein said lighting device is an exterior lighting fixture of a motor vehicle, and said cooling member comprises a curvature adapted to one of an outside contour of said motor vehicle or to a partial surface region of an automobile chassis.

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30. (previously presented) The lighting device comprising an LED arrangement according to claim 29, wherein said LED arrangement is a rotating light, and said cooling member has a cylindrical hollow shape with said printed circuit board applied to an outside wall thereof.

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31. (previously presented) The lighting device according to claim 30, said plurality of LEDs that proceed axially are electrically combined into lanes that can be successively circumferentially operated.

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32. (previously presented) The lighting device having an LED arrangement according to claim 20, wherein said lighting device is an exterior lighting fixture of a motor vehicle, and said cooling member comprises a curvature adapted to one of an outside contour of a motor vehicle or to a partial surface region of an automobile chassis.

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33. (previously presented) The lighting device according to claim 30, wherein said LED arrangement is a rotating light, and said cooling member has a cylindrical hollow shape with said printed circuit board applied to an outside wall thereof.

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34. (previously presented) The lighting device according to claim 33, wherein said plurality of LEDs that proceed axially parallel are electrically combined into lanes that can be successively circumferentially operated.

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- 35. (previously presented) The LED arrangement according to claim 20, wherein the flexible printed circuit board is a flex board.
- 36. (previously presented) The LED arrangement according to claim 23,wherein said metal is selected from the group consisting of copper, aluminum,and sheet metal.
- 37. (previously presented) The LED arrangement according to claim 27, wherein said epoxy resin, polyester or polyamide is in the form of a polyester or polyamide film.